

In re the Application of: Tsuyoshi YAMAMOTO et al.

Group Art Unit: 3729

Application Number: 10/073,106

Examiner: Paul D. Kim

Filed: February 12, 2002

Confirmation Number: 3709

For:

METHOD OF MOUNTING ELECTRONIC COMPONENT ON

SUBSTRATE WITHOUT GENERATION OF VOIDS IN BONDING

**MATERIAL** 

Attorney Docket Number:

020154

**Customer Number:** 

38834

## **REQUEST FOR RECONSIDERATION**

Commissioner for Patents P. O. Box 1450
Alexandria, VA 22313-1450

September 21, 2006

Sir:

This paper is filed in response to the Office Action dated May 23, 2006.

Remarks begin on page 2 of this paper.